74HC4066; 74HCT4066

Quad single-pole single-throw analog switch Rev. 8 — 3 December 2015

Product data sheet

1. **General description**

The 74HC4066; 74HCT4066 is a quad single pole, single throw analog switch. Each switch features two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When nE is LOW, the analog switch is turned off. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

Features and benefits 2.

- Input levels nE inputs:
 - ◆ For 74HC4066: CMOS level
 - ◆ For 74HCT4066: TTL level
- Low ON resistance:
 - 50 Ω (typical) at $V_{CC} = 4.5 \text{ V}$
 - ◆ 45 Ω (typical) at V_{CC} = 6.0 V
 - 35 Ω (typical) at $V_{CC} = 9.0 \text{ V}$
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

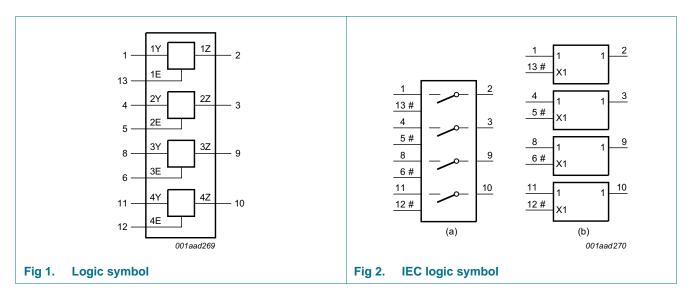


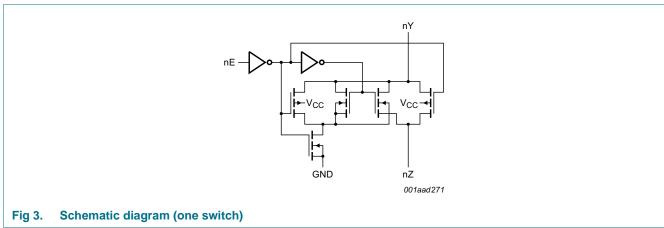
3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | |
|-------------|-------------------|----------|--|----------|--|
| | Temperature range | Name | Description | Version | |
| 74HC4066D | −40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width | SOT108-1 | |
| 74HCT4066D | | | 3.9 mm | | |
| 74HC4066DB | −40 °C to +125 °C | SSOP14 | plastic shrink small outline package; 14 leads; body | SOT337-1 | |
| 74HCT4066DB | | | width 5.3 mm | | |
| 74HC4066PW | -40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body | SOT402-1 | |
| 74HCT4066PW | | | width 4.4 mm | | |
| 74HC4066BQ | –40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very | SOT762-1 | |
| 74HCT4066BQ | | | thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm | | |

4. Functional diagram



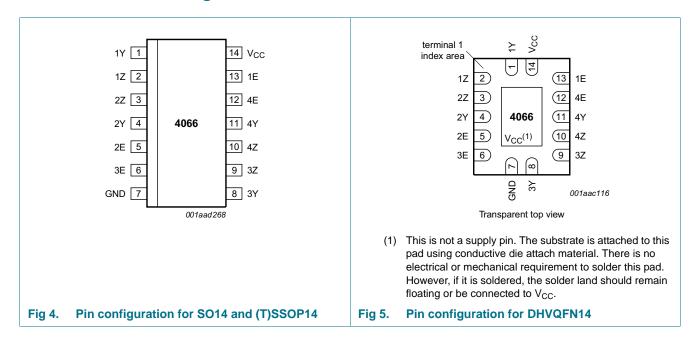


74HC_HCT4066

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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| • | | |
|-----------------|--------------|-----------------------------|
| Symbol | Pin | Description |
| 1Z, 2Z, 3Z, 4Z | 2, 3, 9, 10 | independent input or output |
| 1Y, 2Y, 3Y, 4Y | 1, 4, 8, 11 | independent input or output |
| GND | 7 | ground (0 V) |
| 1E, 2E, 3E, 4E | 13, 5, 6, 12 | enable input (active HIGH) |
| V _{CC} | 14 | supply voltage |

6. Functional description

Table 3. Function table[1]

| Input nE | Switch |
|----------|--------|
| L | OFF |
| Н | ON |

[1] H = HIGH voltage level;

L = LOW voltage level.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|-------------------------|--|------------|------|-------|------|
| V _{CC} | supply voltage | | | -0.5 | +11.0 | V |
| I _{IK} | input clamping current | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$ | | - | ±20 | mA |
| I _{SK} | switch clamping current | $V_{SW} < -0.5 \text{ V or } V_{SW} > V_{CC} + 0.5 \text{ V}$ | | - | ±20 | mA |
| I _{SW} | switch current | $V_{SW} = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$ | <u>[1]</u> | - | ±25 | mA |
| I _{CC} | supply current | | | - | 50 | mA |
| I _{GND} | ground current | | | - | -50 | mA |
| T _{stg} | storage temperature | | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | [2] | | | |
| | | SO14, (T)SSOP14 and DHVQFN14 packages | | - | 500 | mW |
| Р | power dissipation | per switch | | - | 100 | mW |

^[1] To avoid drawing V_{CC} current out of terminal Z, when switch current flows in terminals Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{CC} current will flow out of terminals Yn. In this case there is no limit for the voltage drop across the switch, but the voltages at Yn and Z may not exceed V_{CC} or GND.

For (T)SSOP14 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | 7 | 4HC406 | 6 | 74HCT4066 | | | Unit |
|------------------|-----------------------|--------------------------|-----|--------|-----------------|-----------|------|-----------------|------|
| | | | Min | Тур | Max | Min | Тур | Max | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 10.0 | 4.5 | 5.0 | 5.5 | V |
| VI | input voltage | | GND | - | V _{CC} | GND | - | V _{CC} | V |
| V_{SW} | switch voltage | | GND | - | V _{CC} | GND | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | -40 | +25 | +125 | °C |
| Δt/ΔV | input transition rise | $V_{CC} = 2.0 \text{ V}$ | - | - | 625 | - | - | - | ns/V |
| | and fall rate | V _{CC} = 4.5 V | - | 1.67 | 139 | - | 1.67 | 139 | ns/V |
| | | $V_{CC} = 6.0 \text{ V}$ | - | - | 83 | - | - | - | ns/V |
| | | V _{CC} = 10.0 V | - | - | 35 | - | - | - | ns/V |

^[2] For SO14 package: Ptot derates linearly with 8 mW/K above 70 °C.

9. Static characteristics

Table 6. R_{ON} resistance per switch for types 74HC4066 and 74HCT4066

 $V_I = V_{IH}$ or V_{IL} ; for test circuit see <u>Figure 6</u>.

 V_{is} is the input voltage at a Yn or \overline{Z} terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

For 74HC4066: V_{CC} – GND = 2.0 V, 4.5 V, 6.0 V and 9.0 V.

For 74HCT4066: V_{CC} – GND = 4.5 V.

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to | Unit | |
|-----------------------|---------------------------|---|------------------|--------|-----|-----------|------|---|
| | | | Min | Typ[1] | Max | Min | Max | |
| R _{ON(peak)} | ON resistance (peak) | V _{is} = V _{CC} to GND | | | | | | |
| | | $V_{CC} = 2.0 \text{ V}; I_{SW} = 100 \mu\text{A}$ | - | - | - | - | - | Ω |
| | | $V_{CC} = 4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$ | - | 54 | - | 118 | 142 | Ω |
| | | $V_{CC} = 6.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$ | - | 42 | - | 105 | 126 | Ω |
| | | $V_{CC} = 9.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$ | - | 32 | - | 88 | | Ω |
| R _{ON(rail)} | ON resistance (rail) | V _{is} = GND | | | | | | |
| | | $V_{CC} = 2.0 \text{ V}; I_{SW} = 100 \mu\text{A}$ | - | 80 | - | - | - | Ω |
| | | $V_{CC} = 4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$ | - | 35 | - | 95 | 115 | Ω |
| | | $V_{CC} = 6.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$ | - | 27 | - | 82 | 100 | Ω |
| | | $V_{CC} = 9.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$ | - | 20 | - | 70 | 85 | Ω |
| | | $V_{is} = V_{CC}$ | | | | | | |
| | | $V_{CC} = 2.0 \text{ V}; I_{SW} = 100 \mu\text{A}$ | - | 100 | - | - | - | Ω |
| | | $V_{CC} = 4.5 \text{ V}; I_{SW} = 1000 \mu\text{A}$ | - | 42 | - | 106 | 128 | Ω |
| | | $V_{CC} = 6.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$ | - | 35 | - | 94 | 113 | Ω |
| | | $V_{CC} = 9.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$ | - | 20 | - | 78 | 95 | Ω |
| ΔR_{ON} | ON resistance | V _{is} = V _{CC} to GND | | | | | | |
| | mismatch between channels | $V_{CC} = 2.0 \text{ V}$ [2] | - | - | - | - | - | Ω |
| | OHALITICIS | V _{CC} = 4.5 V | - | 5 | - | - | - | Ω |
| | | V _{CC} = 6.0 V | - | 4 | - | - | - | Ω |
| | | V _{CC} = 9.0 V | - | 3 | - | - | - | Ω |

^[1] Typical values are measured at T_{amb} = 25 °C.

^[2] At supply voltages (V_{CC} – GND) approaching 2 V, the analog switch ON resistance becomes extremely non-linear. Therefore it is recommended that these devices be used to transmit digital signals only, when using these supply voltages.

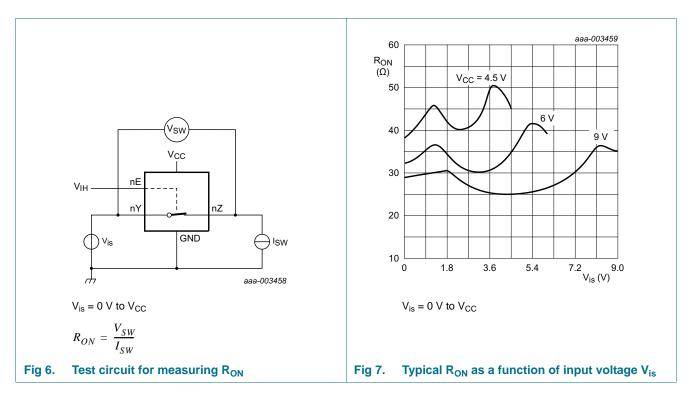


Table 7. Static characteristics 74HC4066

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|-----------------------|---------------------------|---|------|--------|------|------|
| T _{amb} = -4 | 0 °C to +85 °C | | | 1 | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | 1.2 | - | V |
| | | $V_{CC} = 4.5 \text{ V}$ | 3.15 | 2.4 | - | V |
| | | $V_{CC} = 6.0 \text{ V}$ | 4.2 | 3.2 | - | V |
| | | V _{CC} = 9.0 V | 6.3 | 4.7 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | 0.8 | 0.5 | V |
| _ | | $V_{CC} = 4.5 \text{ V}$ | - | 2.1 | 1.35 | V |
| | | $V_{CC} = 6.0 \text{ V}$ | - | 2.8 | 1.80 | V |
| | | V _{CC} = 9.0 V | - | 4.3 | 2.70 | V |
| l _l | input leakage current | V _I = V _{CC} or GND | | | | |
| | | V _{CC} = 6.0 V | - | - | ±1.0 | μΑ |
| ı İI | | V _{CC} = 10.0 V | - | - | ±2.0 | μΑ |
| I _{S(OFF)} | OFF-state leakage current | $V_{CC} = 10.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 8}}{\text{Figure 8}}$ | | | | |
| | | per channel | - | - | ±1.0 | μΑ |
| I _{S(ON)} | ON-state leakage current | $V_{CC} = 10.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 9}}{\text{Figure 9}}$ | - | - | ±1.0 | μΑ |

 Table 7.
 Static characteristics 74HC4066 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

Vos is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|-----------------------|--|---|--------------|--------|------|------|
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $V_{is} = GND$ or V_{CC} ; $V_{os} = V_{CC}$ or GND | | | | |
| | | V _{CC} = 6.0 V | - | - | 20.0 | μΑ |
| | | V _{CC} = 10.0 V | - | - | 40.0 | μΑ |
| Cı | input capacitance | | - | 3.5 | - | pF |
| C _{sw} | switch capacitance | | - | 8 | - | pF |
| T _{amb} = -4 | 0 °C to +125 °C | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | - | - | V |
| | | $V_{CC} = 4.5 \text{ V}$ | 3.15 | - | - | V |
| | | $V_{CC} = 6.0 \text{ V}$ | 4.2 | - | - | V |
| | | $V_{CC} = 9.0 \text{ V}$ | 6.3 | - | - | V |
| V _{IL} | LOW-level input voltage $V_{CC} = 2.0 \text{ V}$ | - | 0.50 | V | | |
| / _{IL} | | $V_{CC} = 4.5 \text{ V}$ | - | - | 1.35 | V |
| | | $V_{CC} = 6.0 \text{ V}$ | - | - | 1.80 | V |
| | | $V_{CC} = 9.0 \text{ V}$ | - | - | 2.70 | V |
| I _I | input leakage current | $V_I = V_{CC}$ or GND | 40.0 - 3.5 8 | | | |
| | | V _{CC} = 6.0 V | - | - | ±1.0 | μΑ |
| | | V _{CC} = 10.0 V | - | - | ±2.0 | μΑ |
| I _{S(OFF)} | OFF-state leakage current | $V_{CC} = 10.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 8}}{\text{Figure 8}}$ | | | | |
| | | per channel | - | - | ±1.0 | μΑ |
| I _{S(ON)} | ON-state leakage current | $V_{CC} = 10.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 9}}{\text{Figure 9}}$ | - | - | ±1.0 | μА |
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $V_{is} = GND$ or V_{CC} ; $V_{os} = V_{CC}$ or GND | | | | |
| | | V _{CC} = 6.0 V | - | - | 40 | μΑ |
| | | V _{CC} = 10.0 V | - | - | 80 | μΑ |

^[1] Typical values are measured at T_{amb} = 25 °C.

Table 8. Static characteristics 74HCT4066

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

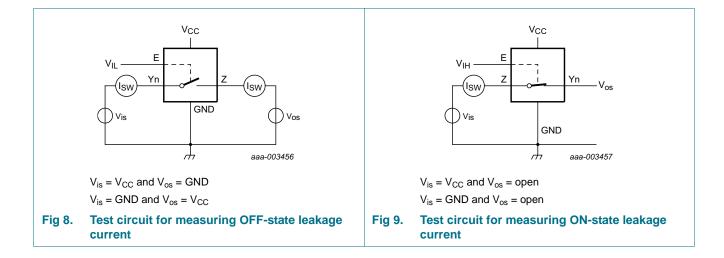
| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit | | | |
|-----------------|------------------------------|---|-----|--------|------|------|--|--|--|
| $T_{amb} = -40$ | $T_{amb} = -40$ °C to +85 °C | | | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 2.0 | 1.6 | - | V | | | |
| V_{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | - | 1.2 | 0.8 | V | | | |
| I _I | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$ | - | - | ±1.0 | μΑ | | | |

Table 8. Static characteristics 74HCT4066 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|------------------------|---------------------------|--|-----|--------|------|------|
| I _{S(OFF)} | OFF-state leakage current | $V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 8}}{\text{Figure 8}}$ | | | | |
| | | per channel | - | - | ±1.0 | μΑ |
| I _{S(ON)} | ON-state leakage current | $V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 9}}{\text{Figure 9}}$ | - | - | ±1.0 | μА |
| lcc | supply current | $V_I = V_{CC}$ or GND; $V_{is} = GND$ or V_{CC} ; $V_{os} = V_{CC}$ or GND; $V_{CC} = 4.5$ V to 5.5 V | - | - | 20.0 | μА |
| Δl _{CC} | additional supply current | per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V | - | 100 | 450 | μА |
| Cı | input capacitance | | - | 3.5 | - | pF |
| C _{sw} | switch capacitance | | - | 8 | - | pF |
| T _{amb} = -40 |) °C to +125 °C | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 4.5 V to 5.5 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 4.5 V to 5.5 V | - | - | 0.8 | V |
| lı | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$ | - | - | ±1.0 | μΑ |
| S(OFF) | OFF-state leakage current | $V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 8}}{\text{Figure 8}}$ | | | | |
| | | per channel | - | - | ±1.0 | μΑ |
| I _{S(ON)} | ON-state leakage current | $V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 9}}{\text{Figure 9}}$ | - | - | ±1.0 | μΑ |
| lcc | supply current | $V_I = V_{CC}$ or GND; $V_{is} = GND$ or V_{CC} ; $V_{os} = V_{CC}$ or GND; $V_{CC} = 4.5$ V to 5.5 V | - | - | 40 | μА |
| Δl _{CC} | additional supply current | per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V | - | - | 490 | μА |

[1] Typical values are measured at T_{amb} = 25 °C.



10. Dynamic characteristics

Table 9. Dynamic characteristics 74HC4066

GND = 0 V; $t_r = t_f = 6$ ns; $C_L = 50$ pF unless specified otherwise; for test circuit see <u>Figure 12</u>.

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

Vos is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

| Symbol | Parameter | Conditions | | -40 | °C to +85 | o°C | –40 °C to | +125 °C | Unit |
|------------------|-------------------------------|--|-----|-----|-----------|------------|-----------|--|------|
| | | | | Min | Typ[1] | Max | Min | 90 18 15 12 225 45 - 38 30 150 30 - 26 | |
| t _{pd} | propagation delay | nY to nZ or nZ to nY; $R_L = \infty \Omega$; see <u>Figure 10</u> | [2] | | | | | | |
| | | V _{CC} = 2.0 V | | - | 8 | 75 | - | 90 | ns |
| | | V _{CC} = 4.5 V | | - | 3 | 15 | - | 18 | ns |
| | | V _{CC} = 6.0 V | | - | 2 | 13 | - | 15 | ns |
| | | V _{CC} = 9.0 V | | - | 2 | 10 | - | 90 18 15 12 225 45 - 38 30 150 30 - | ns |
| t _{off} | turn-off time | nE to nY or nZ; see Figure 11 | [4] | | | | | - 225 | |
| | | V _{CC} = 2.0 V | | - | 44 | 190 | - | | ns |
| | | V _{CC} = 4.5 V | | - | 16 | 16 38 - 45 | 45 | ns | |
| | | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$ | | - | 13 | - | - | - | ns |
| | | V _{CC} = 6.0 V | | - | 13 | 33 | - | 38 | ns |
| | | V _{CC} = 9.0 V | | - | 16 | 26 | - | 90 18 15 12 225 45 - 38 30 150 30 - 26 | ns |
| t _{on} | turn-on time | nE to nY or nZ; see Figure 11 | [3] | | | | | | |
| | | V _{CC} = 2.0 V | | - | 36 | 125 | - | 150 | ns |
| | | V _{CC} = 4.5 V | | - | 13 | 25 | - | 30 | ns |
| | | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$ | | - | 11 | - | - | - | ns |
| | | V _{CC} = 6.0 V | | - | 10 | 21 | - | 26 | ns |
| | | V _{CC} = 9.0 V | | - | 8 | 16 | - | 20 | ns |
| C _{PD} | power dissipation capacitance | per switch; $V_I = GND$ to V_{CC} | [5] | 11 | | - | - | - | pF |

- [1] Typical values are measured at T_{amb} = 25 °C.
- [2] t_{pd} is the same as t_{PHL} and t_{PLH} .
- [3] t_{on} is the same as t_{PHZ} and t_{PLZ} .
- [4] t_{off} is the same as t_{PZH} and t_{PZL} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i + \sum \{(C_L + C_{sw}) \times V_{CC}{}^2 \times f_o\}$ where:

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 $\sum \{(C_L + C_{sw}) \times V_{CC}^2 \times f_o\} = \text{sum of outputs};$

C_L = output load capacitance in pF;

C_{sw} = switch capacitance in pF;

 V_{CC} = supply voltage in V.

Table 10. Dynamic characteristics 74HCT4066

GND = 0 V; $t_r = t_f = 6$ ns; $C_L = 50$ pF unless specified otherwise; for test circuit see <u>Figure 12</u>.

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

Vos is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

| Symbol | Parameter | ameter Conditions | | -40 | °C to +85 | S °C | –40 °C to | +125 °C | Unit |
|------------------|-------------------------------|--|-----------|-----|-----------|------|-----------|---------|------|
| | | | | Min | Typ[1] | Max | Min | Max | |
| t _{pd} | propagation delay | nY to nZ or nZ to nY; $R_L = \infty \Omega$; see Figure 10 | 2] | | | | | | |
| | | V _{CC} = 4.5 V | | - | 3 | 15 | - | 18 | ns |
| t _{off} | turn-off time | nE to nY or nZ; see Figure 11 | 4] | | | | | | |
| | | V _{CC} = 4.5 V | | - | 20 | 44 | - | 53 | ns |
| | | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$ | | - | 16 | - | - | - | ns |
| t _{on} | turn-on time | nE to nY or nZ; see Figure 11 | 3] | | | | | | |
| | | V _{CC} = 4.5 V | | - | 12 | 30 | - | 36 | ns |
| | | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$ | | - | 12 | - | - | - | ns |
| C _{PD} | power dissipation capacitance | per switch; V _I = GND to (V _{CC} – 1.5 V) | <u>5]</u> | - | 12 | - | - | - | pF |

- [1] Typical values are measured at T_{amb} = 25 °C.
- [2] t_{pd} is the same as t_{PHL} and t_{PLH}.
- [3] t_{on} is the same as t_{PHZ} and t_{PLZ} .
- [4] t_{off} is the same as t_{PZH} and t_{PZL} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i + \sum \{(C_L + C_{sw}) \times V_{CC}{}^2 \times f_o\}$ where:

 f_i = input frequency in MHz;

fo = output frequency in MHz;

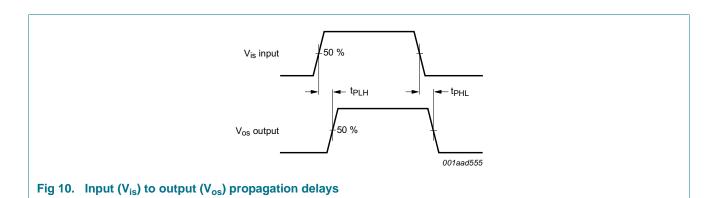
 $\sum \{(C_L + C_{sw}) \times V_{CC}^2 \times f_0\} = \text{sum of outputs};$

C_L = output load capacitance in pF;

C_{sw} = switch capacitance in pF;

 V_{CC} = supply voltage in V.

11. Waveforms



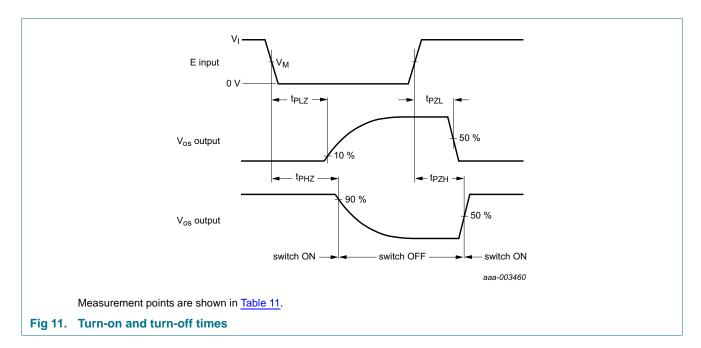
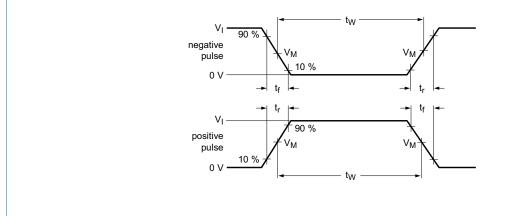
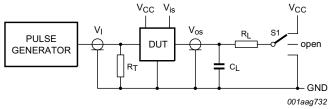


Table 11. Measurement points

| Туре | V _I | V _M |
|-----------|----------------|--------------------|
| 74HC4066 | V_{CC} | 0.5V _{CC} |
| 74HCT4066 | 3.0 V | 1.3 V |





Test data is given in Table 12.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

 C_L = Load capacitance including jig and probe capacitance.

R_L = Load resistance.

S1 = Test selection switch.

Fig 12. Test circuit for measuring switching times

Table 12. Test data

| Test | Input | | Output | Output | | | |
|-------------------------------------|------------------------|------------------------|---------------------------------|----------------|----------------|-----------------|--|
| | Control E | Switch Yn (Z) | t _r , t _f | Switch Z (Yn) | | | |
| | V _I [1] | V _{is} | | C _L | R _L | | |
| t _{PHL} , t _{PLH} | GND | GND to V _{CC} | 6 ns | 50 pF | - | open | |
| t _{PHZ} , t _{PZH} | GND to V _{CC} | V _{CC} | 6 ns | 50 pF, 15 pF | 1 kΩ | GND | |
| t _{PLZ} , t _{PZL} | GND to V _{CC} | GND | 6 ns | 50 pF, 15 pF | 1 kΩ | V _{CC} | |

[1] For 74HCT4066: maximum input voltage $V_I = 3.0 \text{ V}$.

12. Additional dynamic characteristics

Table 13. Additional dynamic characteristics

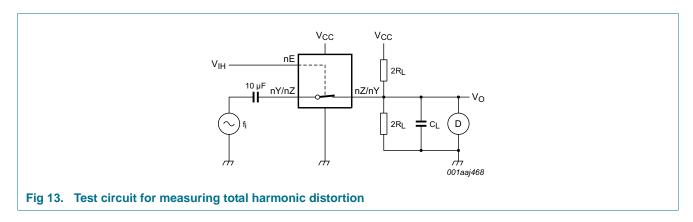
Recommended conditions and typical values; GND = 0 V; T_{amb} = 25 °C.

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

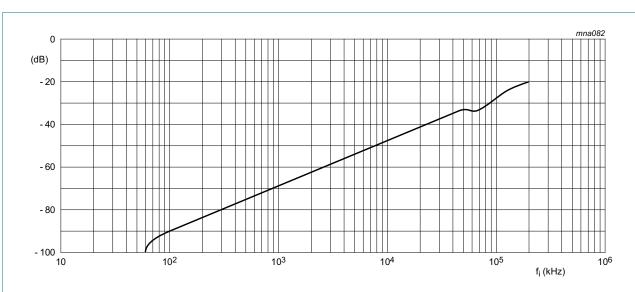
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|---------------------------|---|-----|------|-----|------|
| THD | total harmonic distortion | f_i = 1 kHz; R_L = 10 k Ω ; C_L = 50 pF; see Figure 13 | | | | % |
| | | V _{CC} = 4.5 V; V _I = 4.0 V (p-p) | - | 0.04 | - | % |
| | | $V_{CC} = 9.0 \text{ V}; V_I = 8.0 \text{ V (p-p)}$ | - | 0.02 | - | % |
| | | f_i = 10 kHz; R_L = 10 k Ω ; C_L = 50 pF; see Figure 13 | | | | |
| | | V _{CC} = 4.5 V; V _I = 4.0 V (p-p) | - | 0.12 | - | % |
| | | $V_{CC} = 9.0 \text{ V}; V_I = 8.0 \text{ V (p-p)}$ | - | 0.06 | - | % |
| f _(-3dB) | -3 dB frequency response | $R_L = 50 \Omega$; $C_L = 10 pF$; see <u>Figure 15</u> | | | | |
| | | V _{CC} = 4.5 V | - | 180 | - | MHz |
| | | V _{CC} = 9.0 V | - | 200 | - | MHz |
| α_{iso} | isolation (OFF-state) | $R_L = 600 \Omega$; $C_L = 50 pF$; $f_i = 1 MHz$; see Figure 14 | | | | |
| | | V _{CC} = 4.5 V | - | -50 | - | dB |
| | | V _{CC} = 9.0 V | - | -50 | - | dB |
| V _{ct} | crosstalk voltage | between digital input and switch (peak to peak value); $R_L = 600 \Omega$; $C_L = 50 pF$; $f_i = 1 MHz$; see Figure 16 | | | | |
| | | V _{CC} = 4.5 V | - | 110 | - | mV |
| | | V _{CC} = 9.0 V | - | 220 | - | mV |
| Xtalk | crosstalk | between switches; R _L = 600 Ω ; C _L = 50 pF; [1] f_i = 1 MHz; see Figure 17 | | | | |
| | | V _{CC} = 4.5 V | - | -60 | - | dB |
| | | V _{CC} = 9.0 V | - | -60 | - | dB |

- [1] Adjust input voltage V_{is} to 0 dBm level (0 dBm = 1 mW into 600 Ω).
- [2] Adjust input voltage V_{is} to 0 dBm level at V_{os} for f_i = 1 MHz (0 dBm = 1 mW into 50 Ω). After set-up, f_i is increased to obtain a reading of -3 dB at V_{os} .

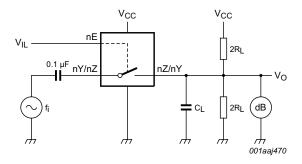


74HC_HCT4066

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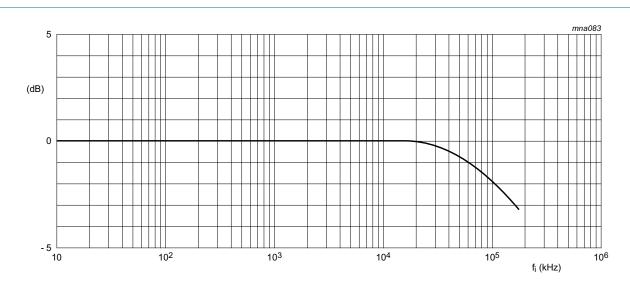
a. Isolation (OFF-state)



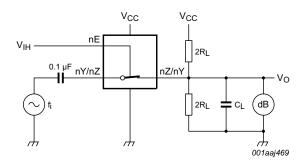
b. Test circuit

 V_{CC} = 4.5 V; GND = 0 V; R_L = 600 Ω ; R_{source} = 1 k Ω .

Fig 14. Isolation (OFF-state) as a function of frequency



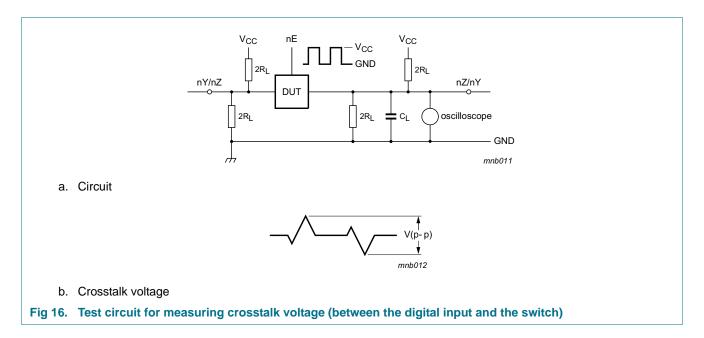
a. Typical -3 dB frequency response

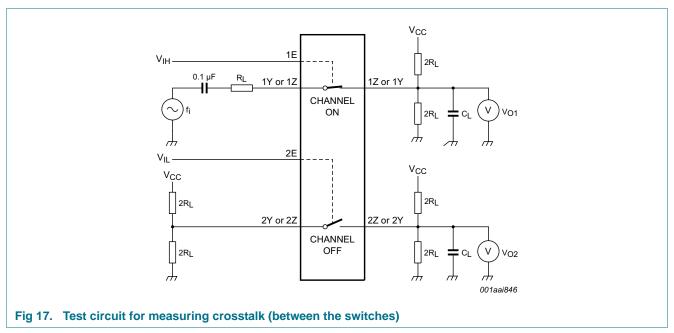


b. Test circuit

 V_{CC} = 4.5 V; GND = 0 V; R_L = 50 $\Omega;$ R_{source} = 1 $k\Omega.$

Fig 15. -3 dB frequency response

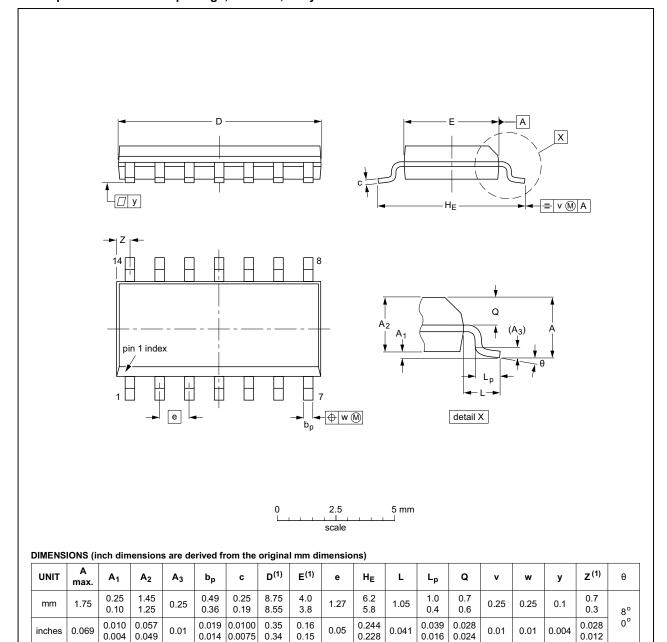




13. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

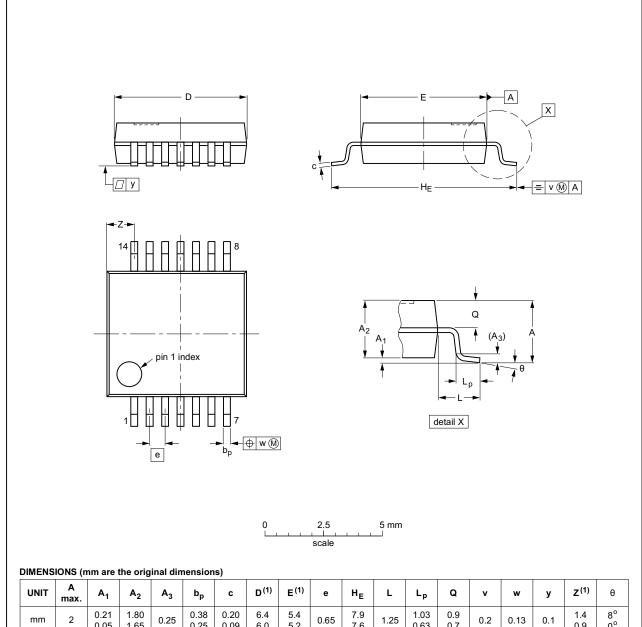
| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|----------|--------|--------|----------|------------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE | |
| SOT108-1 | 076E06 | MS-012 | | | | 99-12-27 03-02-19 | |

Fig 18. Package outline SOT108-1 (SO14)

74HC_HCT4066

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | C | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | ٧ | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|-----------------------|----------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm | 2 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 6.4 6.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 1.4 0.9 | 8° 0° |

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|----------|-----|--------|----------|------------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE | |
| SOT337-1 | | MO-150 | | | | 99-12-27 03-02-19 | |

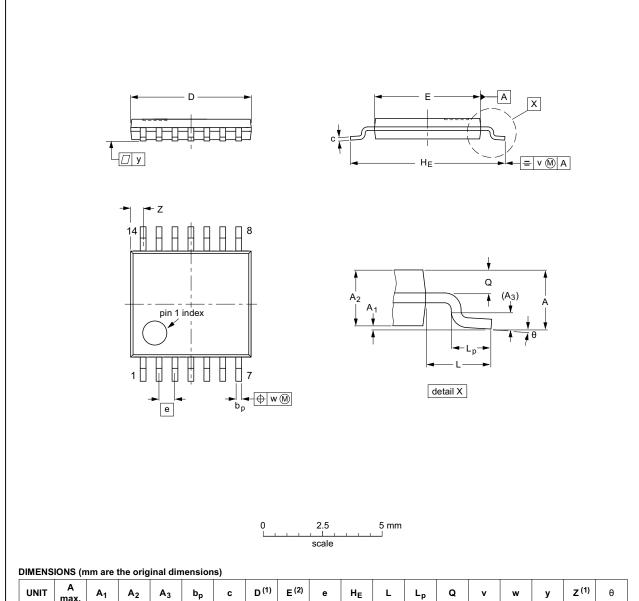
Fig 19. Package outline SOT337-1 (SSOP14)

74HC_HCT4066

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



| | | | | | | -, | | | | | | | | | | | | |
|------|-----------|----------------|----------------|----------------|--------------|------------|------------------|------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E (2) | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
| mm | 1.1 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 5.1 4.9 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.72 0.38 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|----------|-----|--------|----------|------------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE | |
| SOT402-1 | | MO-153 | | | | 99-12-27 03-02-18 | |
| | | | | | | 03-02-16 | |

Fig 20. Package outline SOT402-1 (TSSOP14)

74HC_HCT4066

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm

SOT762-1

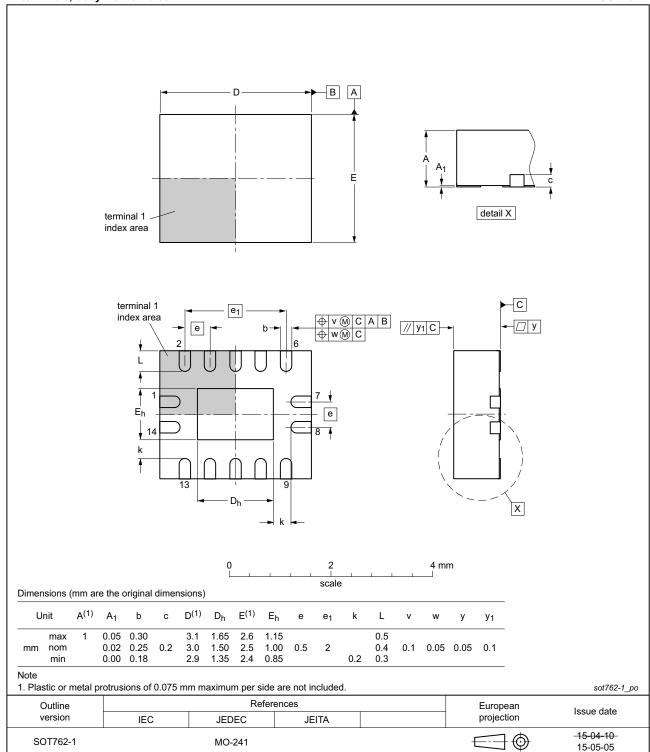


Fig 21. Package outline SOT762-1 (DHVQFN14)

74HC_HCT4066

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14. Abbreviations

Table 14. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

15. Revision history

Table 15. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------------|------------------------------------|-------------------------------|---------------------|----------------------|
| 74HC_HCT4066 v.8 | 20151203 | Product data sheet | - | 74HC_HCT4066 v.7 |
| Modifications: | Type numbers | s 74HC4066N and 74HCT4066 | SN (SOT27-1) remov | ved. |
| 74HC_HCT4066 v.7 | 20130402 | Product data sheet | - | 74HC_HCT4066 v.6 |
| Modifications: | Descriptive tit | le corrected (errata). | | |
| | New general | description (errata). | | |
| 74HC_HCT4066 v.6 | 20120718 | Product data sheet | - | 74HC_HCT4066 v.5 |
| Modifications: | | this data sheet has been rede | signed to comply wi | th the new identity |
| | Legal texts ha | ave been adapted to the new c | ompany name wher | e appropriate. |
| 74HC_HCT4066 v.5 | 20041111 | Product data sheet | - | 74HC_HCT4066 v.4 |
| 74HC_HCT4066 v.4 | 20030617 | Product data sheet | - | 74HC_HCT4066_CNV v.3 |
| 74HC_HCT4067_CNV v.3 | 19981110 | Product data sheet | - | 74HC_HCT4066_CNV v.2 |
| 74HC_HCT4066_CNV v.2 | 19981002 | Product specification | - | - |

16. Legal information

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|--------------------------------|-------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions"
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74HC_HCT4066

74HC4066; 74HCT4066

Quad single-pole single-throw analog switch

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